



7	6	5	4	3	2		
NOTES: UNLESS OTHERWISE SPECIFIED 1 Rohs Compliant Assembly Required. Assemble per IPC—A— 2 AQUEOUS BASED CLEANING AFTER SOLDER FOR ALL COMPONENT ROHS SOLDER PROCESS IS ACCEPTABLE. 3 ITEM IDENTIFICATION: MARK REVISION NUMBER OF THIS DRAWING	NTS IS PREFERRED, NO—CLEAN				REV DESCRIPTION O1 INITIAL RELEASE O2 PANEL ROUTE REDEFINED, DOCUMEN O3 REPOSITION C5 AND R2	REVISIONS DATE APRVD 07/08/2016 NTATION CHANGES. 09/07/2016	
			C4 \(\varphi \)				
			ASSEMBLY TOP				
				UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE	APPROVALS DATE DESIGNER F. PRICE 09/07/2016 1511 Sixth	SYNAPSE Ave. Suite 300, Seattle, WA 98101 206.381.0898	
					SIZE DWG NO	RINTED CIRCUIT BOARD ASSEMBLY Chicklet Indian Rev D REV 600-100857 SHEET 3 OF 4	
7	6	5	4	3	2	1	

